

C0603X360JATACTU

Aliases (CO603X360JATAC7867) SMD Comm X8G HT150C Flex, Ceramic, 36 pF, 5%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0603, 0.4 mm



Click here for the 3D model.

General Information	eneral Information		
Series	SMD Comm X8G HT150C Flex		
Style	SMD Chip		
Description	SMD, MLCC, High Temperature, Ultra-Stable		
Features	High Temperature, Ultra-Stable		
RoHS	Yes		
Termination	Flexible Termination		
Marking	No		
AEC-Q200	No		
Typical Component Weight	4.6 mg		
Shelf Life	78 Weeks		
MSL	1		

	Specifications	
0603	Capacitance	36 pF
1.6mm +/-0.17mm	Measurement Condition	1 MHz 1.0Vrms
0.8mm +/-0.15mm	Tolerance	5%
0.8mm +/-0.15mm	Voltage DC	250 VDC
0.4mm MIN	Dielectric Withstanding Voltage	625 VDC
0.45mm +/-0.15mm	Temperature Range	-55/+150°C
	Temp. Coefficient	X8G
	Capacitance Change with	30 ppm/C, 1MegaHz 1.0Vrms
T&R, 180mm, Paper Tape	Reference to +25°Č and 0 VDC Applied (TCC)	
4000	Dissipation Factor	0.1% 1 MHz 1.0Vrms

Aging Rate

Insulation Resistance

Dimensions Chip Size L W Т s в

Packaging Specifications

Packaging	T&R, 180mm, Paper Tape
Packaging Quantity	4000

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0% Loss/Decade Hour: Referee

Time is 1000 Hours

100 GOhms